



Product Change Notification

112913 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

America's OEM Contact: Kevin Hinkey

Phone: (971) 712-8718 e-mail: Kevin.r.hinkey@intel.com

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 112913 - 00
Change Title: Intel® Centrino® Wireless-N 105 and Intel® Centrino® Wireless-N 135 SKUs:
105BN.HMWG; 105BN.HMWWB;
135BN.HMWG; 135BN.HMWGBR;
135BN.HMWWB
PCN 112913-00, Product Material
PCB Material Change
Date of Publication: March 4, 2014

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 22, 2014
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Description of Change to the Customer:

The Intel® Centrino® Wireless-N 105 and Intel® Centrino® Wireless-N 135 SKUs listed in this PCN will undergo the following change:

The current printed circuit board FR4 material S1155 has been discontinued and will be replaced by S1150G. S1150G has passed UL certification and was determined to be equivalent to S1155. S1150G has been fully qualified and all 2014 released products were developed with S1150G. The only impact is a change to the UL Marking on some of the PCB suppliers.

Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only. No change to form fit or function. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
105BN.HMWG	917353	G41432-006	G41432-007
135BN.HMWG	917357	G40514-006	G40514-007
105BN.HMWWB	920121	G55003-003	G55003-004
135BN.HMWWB	920122	G55004-003	G55004-004
135BN.HMWGBR	925872	G79097-001	G79097-002

PCN Revision History:

Date of Revision:

March 4, 2014

Revision Number:

00

Reason:

Originally Published PCN